

DW05-4RDA-S

Features

- Array of surge rated diodes with internal TVS diode
- Protects four I/O lines
- Low operating and clamping voltage
- Low capacitance(<15pF) for high-speed interfaces
- Solid-state technology

IEC Compatibility (EN61000-4)

- IEC 61000-4-2 (ESD) ±15kV (air), ±8kV (contact)
- IEC 61000-4-4 (EFT) 40A (5/50ns)
- IEC 61000-4-5 (Lightning) 24A (8/20µs)

Mechanical Characteristics

- JEDEC SOIC-8 package
- Molding compound flammability rating: UL 94V-0
- Marking : Making Code, logo, date code
- Packaging : Tape and Reel per EIA 481
- Lead Finish: SnPb or Matte Sn
- RoHS Compliant

Applications

- USB Power and Data Line Protection
- T1/E1 secondary IC Side Protection
- T3/E3 secondary IC Side Protection
- HDSL, SDSL secondary IC Side Protection

Schematic and PIN Configuration

- Video Line Protection
- Microcontroller Input Protection
- Base stations
- I²C Bus Protection



Circuit diagram





Absolute Maximum Rating					
Rating	Symbol	Value	Units		
Peak Pulse Power ($t_p=8/20\mu s$)	P _{PP}	500	Watts		
Peak Forward Voltage ($I_{F}\text{=}1\text{A},t_{p}\text{=}8/20\mu\text{s}$)	V _{FP}	1.5	V		
Lead Soldering Temperature	TL	260(10 sec.)	°C		
Operating Temperature	TJ	-55 to + 125	°C		
Storage Temperature	T _{STG}	-55 to +150	°C		

Electrical Parameters (T=25℃)

Symbol	Parameter
PP	Maximum Reverse Peak Pulse Current
Vc	Clamping Voltage @ IPP
VRWM	Working Peak Reverse Voltage
IR	Maximum Reverse Leakage Current @ VRWM
VBR	Breakdown Voltage @ I⊤
lτ	Test Current
lf	Forward Current
VF	Forward Voltage @ I⊧



Electrical Characteristics

DW05-4RDA-S						
Parameter	Symbol	Conditions	Minimum	Typical	Maximum	Units
Reverse Stand-Off Voltage	V _{RWM}				5	V
Reverse Breakdown Voltage	V_{BR}	I _t =1mA	6			V
Reverse Leakage Current	I _R	V _{RWM} =5V,T=25°C			8	μΑ
Clamping Voltage	Vc	I _{PP} =1A, t _p =8/20μs			9.8	V
Clamping Voltage	Vc	I _{PP} =10A, t _p =8/20μs			12	V
Clamping Voltage	Vc	I _{PP} =25Α, t _p =8/20μs			20	V
Peak Pulse Current	I _{PP}	t _p =8/20µs			25	А
Junction Canacitance	Cj	Between I/O pins and Ground, V_R =0V, f=1MH _Z		8	15	pF
Junction Capacitance		Between I/O pins V _R =0V, f=1MHz		4		pF





Typical Characteristics



Non-Repetitive Peak Pulse Power vs.Pulse Time





Variation of Capacitance vs. Reverse Voltage





Power Derating curve

Clamping Voltage vs. Peak Pulse Current



Forward Voltage vs. Forward Current





Application Information

Device Connection Options for Protection of four High-Speed Data Lines

The DW05-4RDA-S TVS is designed to protect four data lines from transient over voltages by clamping them to a fixed reference. When the voltage on the protected line exceeds the reference voltage (plus diode V_F) the steering diodes are forward biased, conducting the transient current away from the sensitive circuitry. Data lines are connected at pins 1, 4, 6 and 7. The negative reference is connected at pins 5 and 8. These pins should be connected directly to a ground plane on the board for best results. The path length is kept as short as possible to minimize parasitic inductance. The positive reference is connected at pins 2 and 3. The options for connecting the positive reference are as follows:

 To protect data lines and the power line, connect pins 2 & 3 directly to the positive supply rail (V_{CC}). In this configuration the data lines are referenced to the supply voltage. The internal TVS diode prevents over-voltage on the supply rail.





 The DW05-4RDA-S can be isolated from the power supply by adding a series resistor between pins 2 and 3 and V_{CC}. A value of 10k _ is recommended. The internal TVS and steering diodes remain biased, providing the advantage of lower capacitance.

3. In applications where no positive supply reference is available, or complete supply isolation is desired, the internal TVS may be used as the reference. In this case, pins 2 and 3 are not connected. The steering diodes will begin to conduct when the voltage on the protected line exceeds the working voltage of the TVS (plus one diode drop).









Typical Applications







DW05-4RDA-S

Outline Drawing – SO-8



NOTES:

- 1. Controlling Dimensions Are In Millimeters (Angles In Degrees).
- 2. Datums -A- And -B- To Be Determined At Datum Plane -H-.
- 3. Dimensions "E1" And "D" Do Not Include Mold Flash, Protrusions Or Gate Burrs.
- 4. Reference JEDEC STD MS-012, VARITION AA.



DIMENSIONS			
DIM	INCHES MILLIMETE		
С	(.205)	(5.20)	
G	.118	3.00	
Р	.050	1.27	
х	.024	0.60	
Y	.087	2.20	
z	.291	7.40	

			SO-8	3			
		C	IMENSI	ONS			
DIM	INCHES			MILLIMETERS			
	MIN	NOM	MAX	MIN	NOM	MAX	
А	.053	-	.069	1.35	-	1.75	
A1	.004	-	.010	0.10	-	0.25	
A2	.049	-	.065	1.25	-	1.65	
b	.012	-	.020	0.31	-	0.51	
с	.007	-	.010	0.17	-	0.25	
D	.189	.193	.197	4.80	4.90	5.00	
E1	.150	.154	.157	3.80	3.90	4.00	
Е	.236BSC			6.00BSC			
е	.050 BSC			1.27 BSC			
h	.010	-	.020	0.25	-	0.50	
L	.016	.028	.041	0.40	0.72	1.04	
θ1	0°	-	8°	0°	-	8°	
L1	(.041)		(1.04)				
Ν	8		8				
aaa	.004			0.10			
bbb	.010			0.25			
CCC	.008 0.20						

Notes

1.

2.

- This Land Pattern Is For Reference Purposes Only.Consult Your Manufacturing Group To Ensure Your Company's Manufacturing Guidelines Are Met.
- Reference IPC-SM-782A, RLP NO. 300A.

Marking Codes



Package Information

Qty: 2.5k/Reel